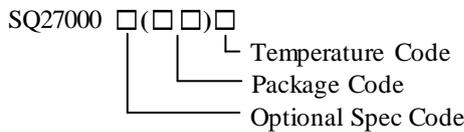


General Description

The SQ27000 develops a high efficiency synchronous step-down DC/DC converter capable of delivering 0.6A current. The SQ27000 operates over a wide input voltage range from 7V to 100V and integrates main switch and synchronous switch with very low $R_{DS(ON)}$ to minimize the conduction loss. The SQ27000 always operates under continuous condition mode. The device adopts the instant PWM architecture to achieve fast transient responses for high step down applications.

Ordering Information



Ordering Number	Package type	Note
SQ27000SXC	DFN4 ×4-8	--

Features

- Low $R_{DS(ON)}$ for Internal Switches (Top/Bottom): 500mΩ/285mΩ
- 7-100V Input Voltage Range
- 0.6A Output Current Capability
- Constant On-time Control
- Instant PWM Architecture to Achieve Fast Transient Responses
- Programmable Switching Frequency Range: 200kHz~1MHz.
- 2ms Internal Soft-start Limits the Inrush Current
- Precise $\pm 2\%$ 1.225V Reference over -40 °C to +125 °C Temperature Range
- Cycle-by-cycle Peak Current Limit
- Over Temperature Protection with Auto Recovery
- RoHS Compliant and Halogen Free
- Compact Package DFN4 ×4-8

Applications

- Isolated Telecom Bias Supply
- Secondary High Voltage Post Regulator
- Automotive Systems

Typical Applications

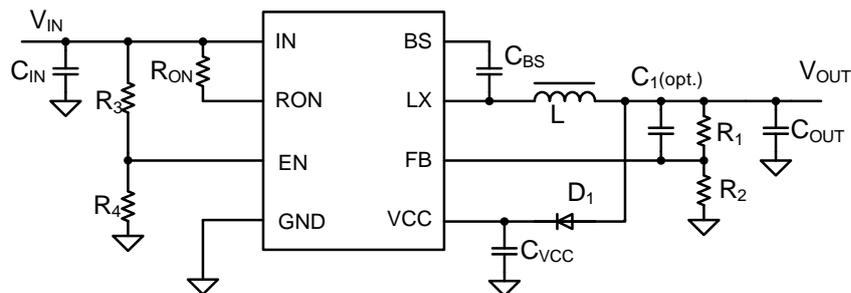


Figure1 (a) Buck Schematic

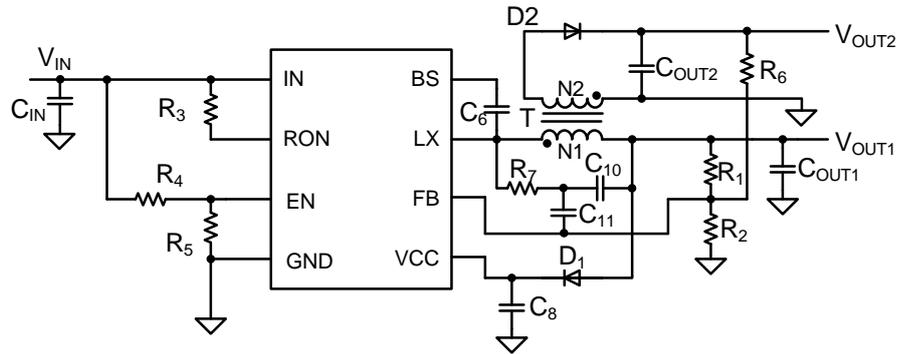


Figure1 (b) Fly-Buck Schematic

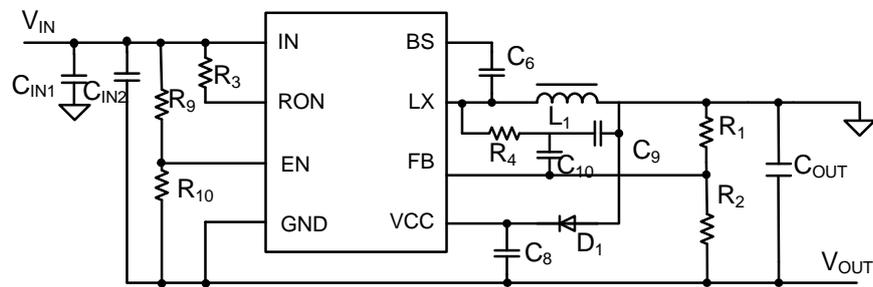
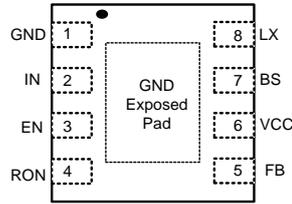


Figure1 (c) Buck-Boost Schematic

Pinout (top view)



(DFN4×4-8)

Top Mark: CHGxyz (Device code: CHG; x=year code, y=week code, z=lot number code)

Pin Name	Pin Number	Pin Description
GND	1, Exposed Pad	Ground pin.
IN	2	Input pin. Decouple this pin to the GND with a low ESR ceramic capacitor.
EN	3	Enable control pin. This pin can also be used for programming V_{IN} turn on voltage with the resistor divider. The device has an accurate 1.225V rising threshold.
RON	4	Connect a resistor from this pin to the IN to set the top switch ON time. The switching frequency can be calculated using the following equation: $f_s \text{ (kHz)} = \frac{11 \times V_{OUT} \text{ (V)} + 500}{R_{ON} \text{ (M}\Omega\text{)}}$
FB	5	Output feedback pin. Connect this pin to the center point of the output resistor divider (as shown in Figure 1) to program the output voltage: $V_{OUT} = 1.225 \times (1 + R_1/R_2)$
VCC	6	Supply input of the internal LDO.
BS	7	Boot-strap pin. Supply high side gate driver. Connect a 0.1 μ F ceramic capacitor between the BS pin and the LX pin.
LX	8	Inductor pin. Connect this pin to the switching node of the inductor.

Block Diagram

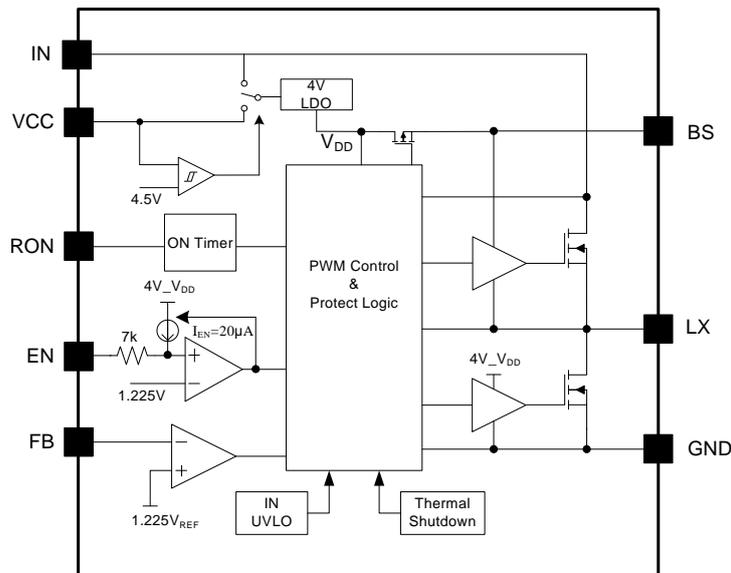


Figure2. Block Diagram



Absolute Maximum Ratings (Note 1)

IN	-0.3V to 100V
EN, LX, RON	-0.3V to VIN + 0.3V
BS-LX	-0.3V to 6V
FB Voltage	-0.3V to 6V
VCC	-0.3V to 30V
Power Dissipation, P _D @ T _A = 25 °C DFN4×4-8	2.8W
Package Thermal Resistance (Note 2)	
θ _{JA}	44.5 °C/W
θ _{JC}	22.1 °C/W
θ _{JB}	14.1 °C/W
Junction Temperature Range	-40 °C to 150 °C
Lead Temperature (Soldering, 10 sec.)	260 °C
Storage Temperature Range	-65 °C to 150 °C
Dynamic LX voltage in 50ns Duration	IN+3V to GND-5V

Recommended Operating Conditions (Note 3)

Supply Input Voltage	7V to 100V
Junction Temperature Range	-40 °C to 125 °C
Ambient Temperature Range	-40 °C to 85 °C

Electrical Characteristics

($V_{IN}=48V$, $V_{OUT}=5V$, $L=33\mu H$, $C_{OUT}=10\mu F$, $I_{OUT}=0.6A$ unless otherwise specified. Typical value corresponds to $T_J=25^\circ C$. Minimum and maximum limits apply over $-40^\circ C$ to $125^\circ C$ junction temperature range.)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Input Voltage Range	V_{IN}		7		100	V
Input UVLO Rising Threshold	$V_{IN,UVLO}$		5.8	6.3	6.8	V
Input UVLO Hysteresis	V_{HYS}		0.15	0.25	0.35	V
Shutdown Current	I_{SHDN}	EN=0		8	30	μA
Feedback Reference Voltage	V_{REF}		1.2	1.225	1.25	V
FB Input Current	I_{FB}	$V_{FB}=3.3V$	-100		100	nA
Top FET RON	$R_{DS(ON)1}$			500		m Ω
Bottom FET RON	$R_{DS(ON)2}$			285		m Ω
Top FET peak Current Limit	$I_{LIM, TOP}$		0.9	1.2	1.5	A
Bottom FET Valley Current Limit	$I_{LIM, BOTTOM}$		0.6	0.8	1	A
Negative Current Limit	$I_{LIM, NEG}$		-480	-650	-820	mA
VCC Input Rising UVLO Threshold	$V_{VCC, UVLO}$			4.5		V
VCC Input UVLO Hysteresis	$V_{VCC, HYS}$			0.3		V
EN Rising Threshold	V_{EN}		1.185	1.225	1.265	V
EN Hysteresis Input Current	$I_{EN, HYS}$		-10	-20	-29	μA
Switching Frequency	f_{OSC}	$V_{IN}=48V$, $R_{ON}=1.1M\Omega$	350	500	650	kHz
Min ON Time	t_{ON}			90		ns
Min OFF Time	t_{OFF}			200		ns
Thermal Shutdown Temperature	T_{SD}			150		$^\circ C$
Thermal Shutdown Hysteresis	T_{HYS}			15		$^\circ C$

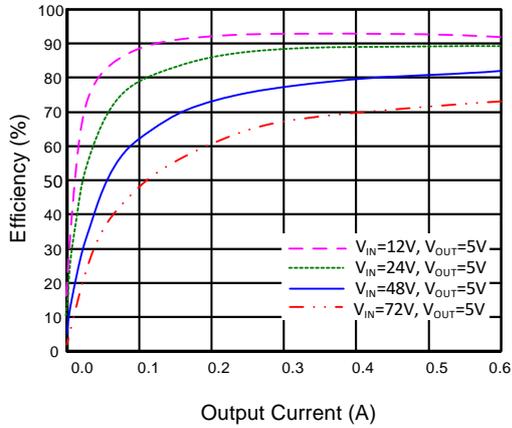
Note 1: Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: θ_{JA} is measured in accordance with JESD51-2 at $T_A = 25^\circ C$ on a high effective 4-layer PCB built according to JESD51-7 with thermal via.

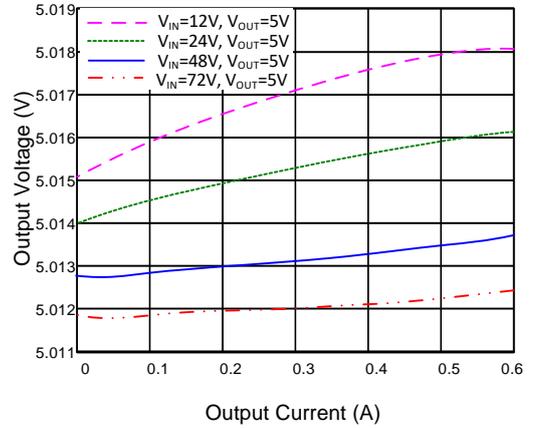
Note 3: The device is not guaranteed to function outside its operating conditions.

Typical Performance Characteristics

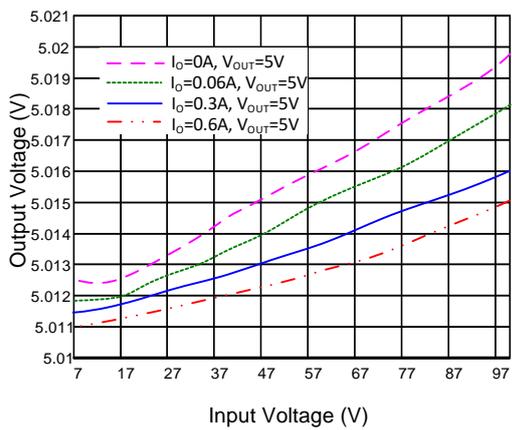
Efficiency vs. Output Current



Output Voltage vs Output Current

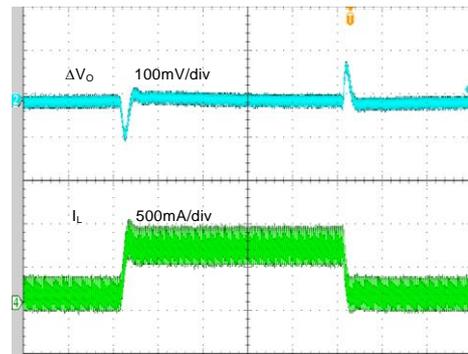


Output Voltage vs Input Voltage



Load Transient

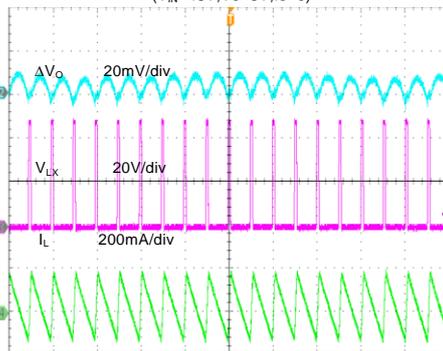
($V_{IN}=48V, V_{OUT}=5V, I_{OUT}=0.06A-0.6A$)



Time (100 μ s/div)

Output Ripple

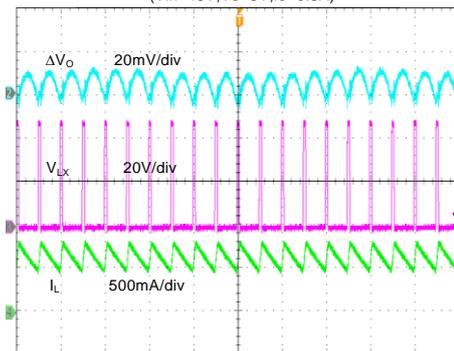
($V_{IN}=48V, V_O=5V, I_O=0$)



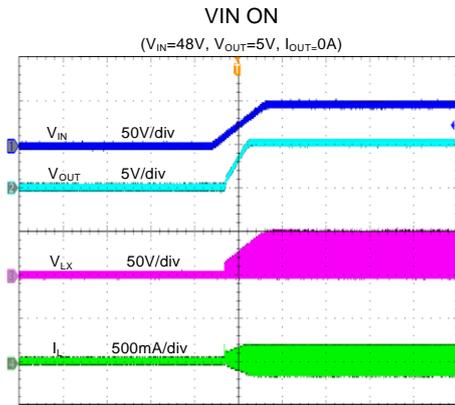
Time (4 μ s/div)

Output Ripple

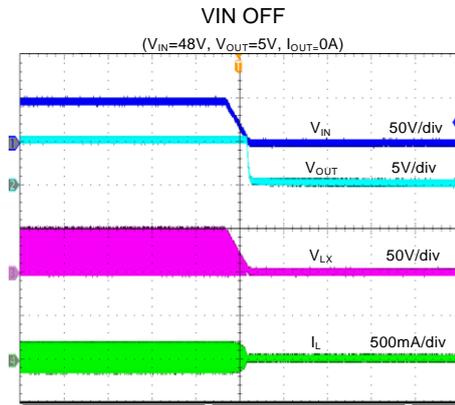
($V_{IN}=48V, V_O=5V, I_O=0.6A$)



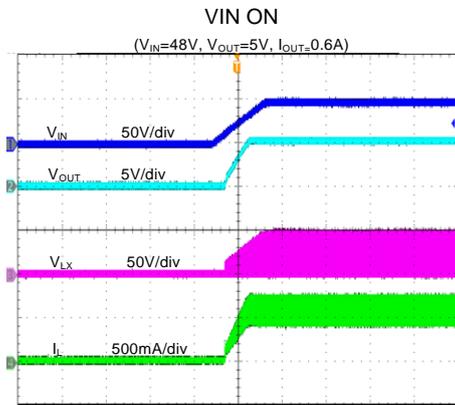
Time (4 μ s/div)



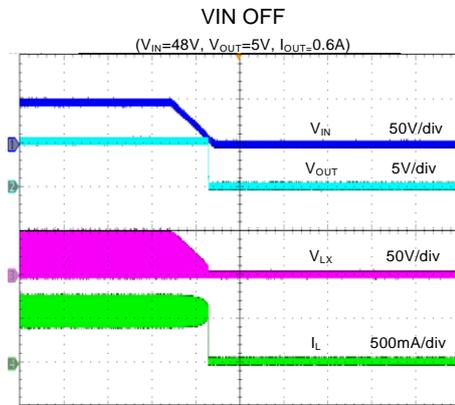
Time (4ms/div)



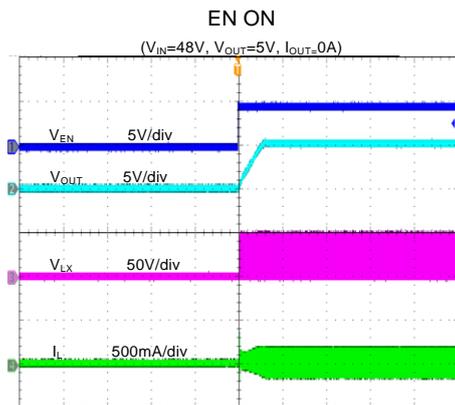
Time (200ms/div)



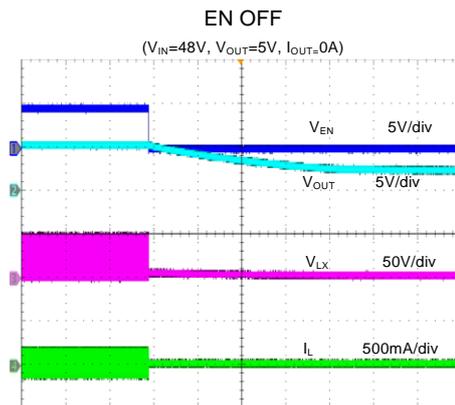
Time (4ms/div)



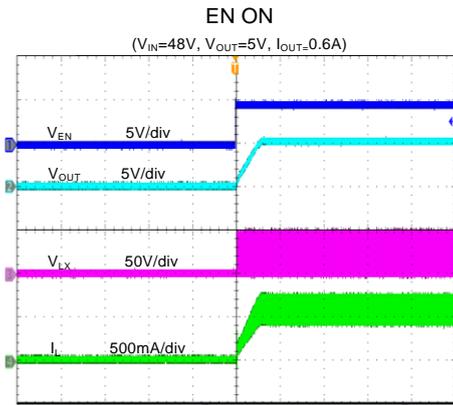
Time (100ms/div)



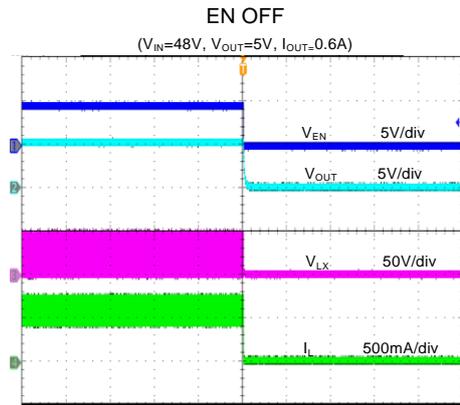
Time (4ms/div)



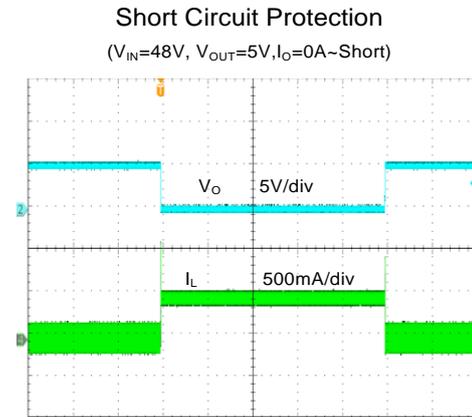
Time (200ms/div)



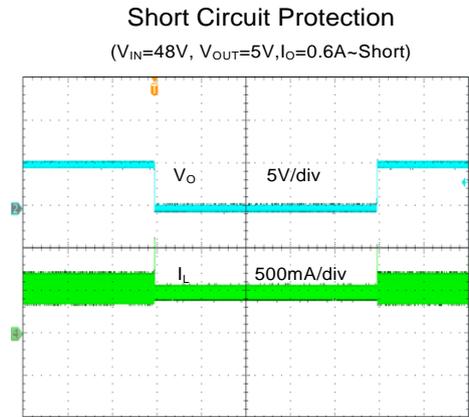
Time (4ms/div)



Time (4ms/div)



Time (10ms/div)



Time (10ms/div)

Detailed Description

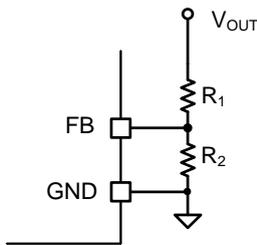
Because of the high integration in the SQ27000 IC, the application circuit based on this regulator is rather simple. Only the on-timer resistor R_{ON} , the feedback resistors (R_1 and R_2), the input capacitor C_{IN} , the output capacitor C_{OUT} and the output inductor L need to be selected for the targeted applications specifications.

Output Voltage Program

Choose R_1 and R_2 to program the proper output voltage. To minimize the power consumption under light loads, it is desirable to choose large resistance values for both R_1 and R_2 .

$$V_{OUT} = \left(1 + \frac{R_1}{R_2}\right) \times V_{FB}$$

V_{FB} is typical 1.225V.



Output Inductor L

There are several considerations in choosing this inductor.

1) Choose the inductance to provide the desired ripple current. It is suggested to choose the ripple current to be about 40% of the maximum output current. The inductance is calculated as:

$$L_1 = \frac{V_{OUT} \times (1 - V_{OUT} / V_{IN_MAX})}{f_s \times I_{OUT_MAX} \times 40\%}$$

Where f_s is the switching frequency and I_{OUT_MAX} is the maximum load current.

The SQ27000 regulator is quite tolerant of different ripple current amplitude. Consequently, the final choice of inductance can be slightly off the calculation value without significantly impacting the performance.

2) The saturation current rating of the inductor must be selected greater than the peak inductor current

under full load conditions.

$$I_{SAT_MIN} > I_{OUT_MAX} + \frac{V_{OUT} \times (1 - V_{OUT} / V_{IN_MAX})}{2f_s \times L_1}$$

3) The DCR of the inductor and the core loss at the switching frequency must be low enough to achieve the desired efficiency requirement. It is desirable to choose an inductor with smaller DCR to achieve a good overall efficiency.

Input Capacitor C_{IN}

The ripple current through the input capacitor is calculated as:

$$I_{CIN_RMS} = I_{OUT_MAX} \times \sqrt{D(1-D)}$$

The capacitance of the input capacitor is calculated as:

$$C_{IN} = \frac{I_{OUT} \times V_{OUT} \times (V_{IN} - V_{OUT})}{\Delta V_{IN} \times f_s \times Eff \times V_{IN}^2}$$

ΔV_{IN} is desired input voltage ripple.

To minimize the potential noise problem, place a typical X5R or better grade ceramic capacitor really close to the IN and the GND pins. Care should be taken to minimize the loop area formed by C_{IN} and the IN/GND pins. In this case, a 1 μ F low ESR ceramic capacitor is recommended.

Output Capacitor C_{OUT}

The output capacitor is selected to handle the output ripple noise requirements. Both steady state ripple and transient requirements must be taken into consideration when selecting this capacitor. It is recommended to use an X5R or better grade ceramic capacitor greater than 10 μ F capacitance.

On-time

The on-time for the SQ27000 is determined by the R_{ON} resistor, and is inversely proportional to the input voltage, resulting in a nearly constant frequency as V_{IN} is varied over its range.

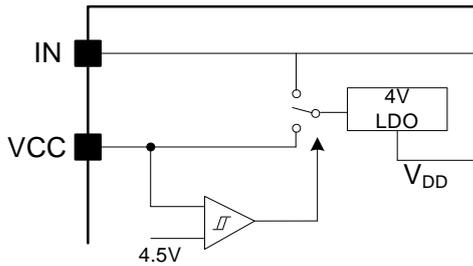
Frequency vs. R_{ON} Resistor:

$$f_s (\text{kHz}) = \frac{11 \times V_o (\text{V}) + 500}{R_{ON} (\text{M}\Omega)}$$

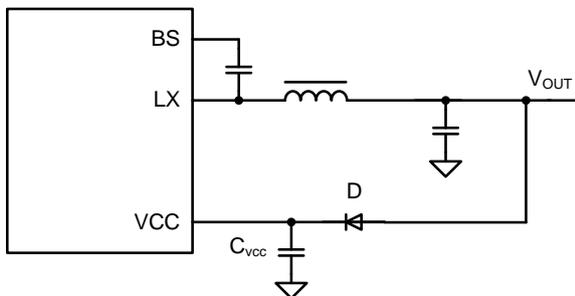
Notice: Final switch frequency is not only affected by component tolerant but also minimum off and on time limit.

Internal LDO Regulator

The SQ27000 has two power supply way for 4V LDO. Upon power up, the 4V LDO regulator is power supplied by V_{IN} . When the voltage on the VDD reaches the under-voltage lockout threshold voltage, the Buck regulator is enabled. After soft start done, if the VCC pin voltage is larger than 4.5V, the power supply of 4V LDO is switched to VCC. A 0.1 μ F ceramic capacitor is recommended for C_{VCC} at most applications.



In applications, the input pin (IN) can be connected directly to the line voltages up to 100 Volts, where power dissipation in the 4V LDO regulator is a concern; an auxiliary voltage can be connected to the VCC pin via a diode. Setting the auxiliary voltage to 4.8 -28V will shut off the LDO power supply from IN and reduce internal LDO power dissipation.



Soft-start

The SQ27000 has a built-in soft-start to control the rise rate of the output voltage and limit the input current surge during IC start-up. The typical soft-start time is 2ms.

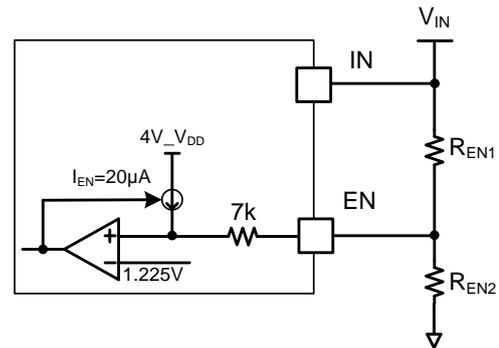
Adjusting Under Voltage Lockout

The EN pin provides electrical on/off control of the device. Once the EN pin voltage exceeds the threshold voltage, the device starts operation. If the EN pin voltage is pulled below the threshold, the regulator stops switching and enters shutdown state. An external set-point voltage divider from V_{IN} to

GND can be used for setting the minimum operating voltage of the regulator. Minimum V_{UVLO} value needs larger than 6.5V.

$$V_{IN,UVLO}(V) = \left(1 + \frac{R_{EN1}}{R_{EN2}}\right) \times V_{EN}$$

V_{EN} is typical 1.225V.

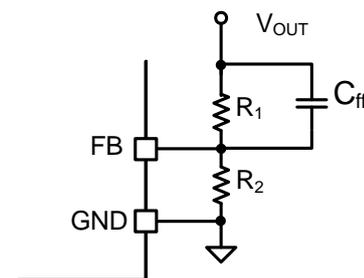


UVLO hysteresis is accomplished with an internal 20 μ A current source that is switched on or off into the impedance of the set-point divider. When the EN threshold is exceeded, the current source is activated to quickly raise the voltage at the EN pin. The UVLO hysteresis is calculated as

$$V_{HYS}(V) = I_{EN} \times R_{EN1} + I_{EN} \times 7k \times \left(1 + \frac{R_{EN1}}{R_{EN2}}\right)$$

Load Transient Considerations

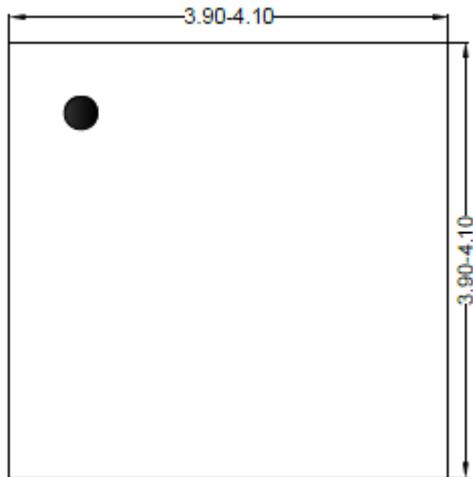
The SQ27000 regulator adopts the instant PWM architecture to achieve good stability and fast transient responses. Adding a C_{ff} ceramic capacitor in parallel with R_1 is recommended.



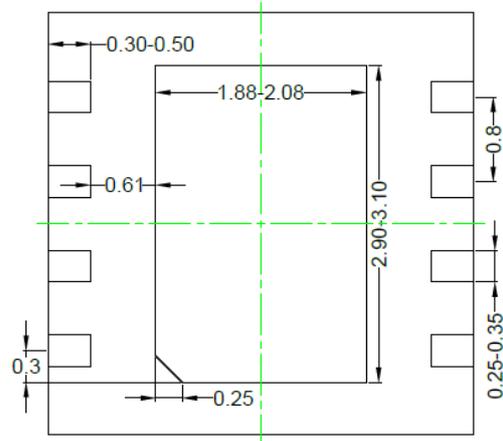
External Boot-strap Capacitor

This capacitor provides the gate driver voltage for internal high side MOSEFET. A 100nF low ESR ceramic capacitor connected between the BS pin and the LX pin is recommended.

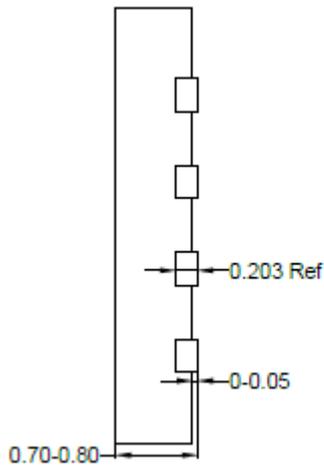
DFN4×4-8 Package Outline & PCB Layout



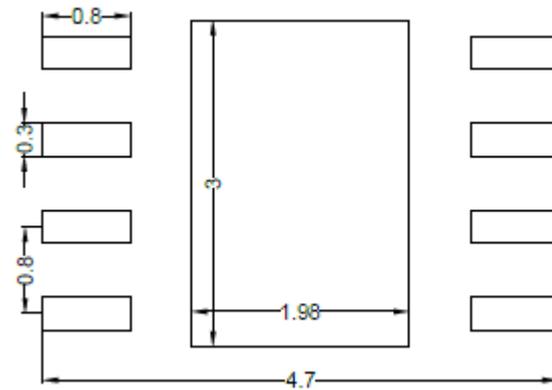
Top View



Bottom View



Side View



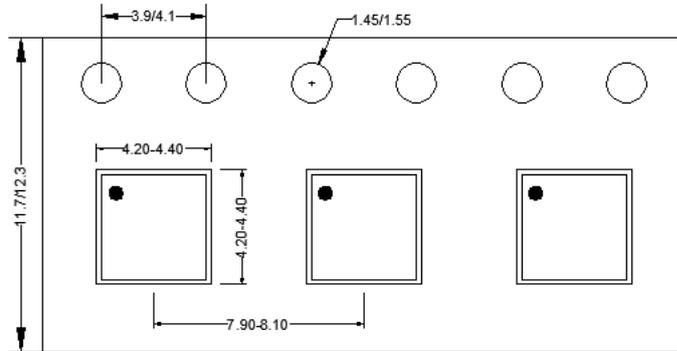
PCB Layout (Reference Only)

Notes: All dimension in millimeter and exclude mold flash & metal burr.

Taping & Reel Specification

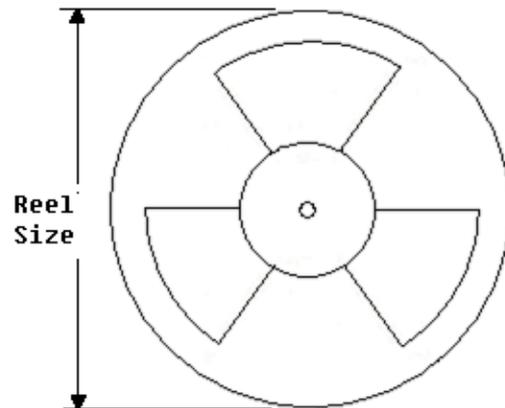
1. Taping orientation

DFN4×4-8



Feeding Direction →

Carrier Tape & Reel specification for packages



Package type	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
DFN4×4-8	12	8	13"	400	400	5000

2. Others: NA



IMPORTANT NOTICE

- 1. Right to make changes.** Silergy and its subsidiaries (hereafter Silergy) reserve the right to change any information published in this document, including but not limited to circuitry, specification and/or product design, manufacturing or descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products are sold subject to Silergy's standard terms and conditions of sale.
- 2. Applications.** Application examples that are described herein for any of these products are for illustrative purposes only. Silergy makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification. Buyers are responsible for the design and operation of their applications and products using Silergy products. Silergy or its subsidiaries assume no liability for any application assistance or designs of customer products. It is customer's sole responsibility to determine whether the Silergy product is suitable and fit for the customer's applications and products planned. To minimize the risks associated with customer's products and applications, customer should provide adequate design and operating safeguards. Customer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Silergy assumes no liability related to any default, damage, costs or problem in the customer's applications or products, or the application or use by customer's third-party buyers. Customer will fully indemnify Silergy, its subsidiaries, and their representatives against any damages arising out of the use of any Silergy components in safety-critical applications. It is also buyers' sole responsibility to warrant and guarantee that any intellectual property rights of a third party are not infringed upon when integrating Silergy products into any application. Silergy assumes no responsibility for any said applications or for any use of any circuitry other than circuitry entirely embodied in a Silergy product.
- 3. Limited warranty and liability.** Information furnished by Silergy in this document is believed to be accurate and reliable. However, Silergy makes no representation or warranty, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. In no event shall Silergy be liable for any indirect, incidental, punitive, special or consequential damages, including but not limited to lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges, whether or not such damages are based on tort or negligence, warranty, breach of contract or any other legal theory. Notwithstanding any damages that customer might incur for any reason whatsoever, Silergy' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Standard Terms and Conditions of Sale of Silergy.
- 4. Suitability for use.** Customer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of Silergy components in its applications, notwithstanding any applications-related information or support that may be provided by Silergy. Silergy products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an Silergy product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Silergy assumes no liability for inclusion and/or use of Silergy products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.
- 5. Terms and conditions of commercial sale.** Silergy products are sold subject to the standard terms and conditions of commercial sale, as published at <http://www.silergy.com/stdterms>, unless otherwise agreed in a valid written individual agreement specifically agreed to in writing by an authorized officer of Silergy. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Silergy hereby expressly objects to and denies the application of any customer's general terms and conditions with regard to the purchase of Silergy products by the customer.
- 6. No offer to sell or license.** Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights. Silergy makes no representation or warranty that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right. Information published by Silergy regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from Silergy under the patents or other intellectual property of Silergy.

For more information, please visit: www.silergy.com

©2020 Silergy Corp.

All Rights Reserved.